

2020 Tower Semiconductor MPW Schedule

	Fab		Tape-In	Ship Date
SB*18 B4300	NPB - Fab 3	SiGe BiCMOS 0.18um	01/14/20	07/22/20
<i>Please contact your sales representative for information on fast track processing.</i>				
CA18 B4301	NPB - Fab 3	RFCMOS 0.18um	02/04/20	07/14/20
<i>Please contact your sales representative for information on fast track processing.</i>				
SB*/CA/13* B4302	NPB - Fab 3	SiGe BiCMOS/RF CMOS 0.13um	02/18/20	10/16/20
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SB*18 B4303	NPB - Fab 3	SiGe BiCMOS 0.18um	03/03/20	09/08/20
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PH18MA B4304	NPB - Fab 3	SiPho 0.18um	03/31/20	08/14/20
CS18* B4305	MH - Fab 2	CMOS-SOI 0.18um includes CS18QT9	04/21/20	
SB*18 B4306	NPB - Fab 3	SiGe BiCMOS 0.18um	04/28/20	11/03/20
<i>Please contact your sales representative for information on fast track processing.</i>				
12th MPW Uozu, Japan	TPSCo - Fab 7	CMOS & PM 65nm	05/06/20	
CA18 B4307	NPB - Fab 3	RFCMOS 0.18um	05/12/20	10/20/20
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13th MPW Tonami, Japan	TPSCo - Fab 5	CMOS 0.18u & 0.16u, PM, PM_SOI	05/25/20	
SH220T18MAY	MH - Fab 2	CIS 0.18um, 0.11um Image Sensor	06/01/20	
		CMOS+ 0.16um, 0.18um RF, RFID, PM	06/01/20	
SB*18 B4309	NPB - Fab 3	SiGe BiCMOS 0.18um	06/23/20	12/29/20
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SB*18 B4530	NPB - Fab 3	SiGe BiCMOS 0.18um	06/23/20	12/29/20
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PH18MA B4308	NPB - Fab 3	SiPho 0.18um	07/07/20	11/20/20
SH320T18AUG	MH - Fab 2	CIS 0.18um, 0.11um Image Sensor	08/03/20	
		CMOS+ 0.16um, 0.18um RF, RFID, PM	08/10/20	
14th MPW Uozu, Japan	TPSCo - Fab 7	RFSOI	08/28/20	
		65nm		
14th MPW Tonami, Japan	TPSCo - Fab 5	CMOS 0.18u & 0.16u, PM, PM_SOI	09/07/20	
SB*18 B4311	NPB - Fab 3	SiGe BiCMOS 0.18um	09/08/20	03/16/21
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CS18* B4312	MH - Fab 2	CMOS-SOI 0.18um	09/22/20	
		includes CS18QT9		
PH18MA B4313	NPB - Fab 3	SiPho 0.18um	10/06/20	02/19/21
13th MPW Uozu, Japan	TPSCo - Fab 7	CMOS & PM	10/15/20	
		65nm		
SB*/CA/13* B4314	NPB - Fab 3	SiGe BiCMOS/RF CMOS 0.13um	10/20/20	06/16/21
<i>Please contact your sales representative for information on fast track processing.</i>				
SH420T18NOV	MH - Fab 2	CIS 0.18um, 0.11um Image Sensor	11/02/20	
		CMOS+ 0.16um, 0.18um RF, RFID, PM	11/09/20	
SB*18 B4315	NPB - Fab 3	SiGe BiCMOS 0.18um	11/10/20	05/18/21
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	Fab		Tape-In	Ship Date
15th MPW Tonami, Japan	TPSCo - Fab 5	CMOS 0.18u & 0.16u, PM, PM_SOI	11/23/20	
CA18 B4316	NPB - Fab 3	RFCMOS 0.18um	12/01/20	05/12/21
<i>Please contact your sales representative for information on fast track processing.</i>				

Notes :

"Shuttles" (SH*) are run at Fab 2

* 0.13u MH - fab 2 Shuttle / MPW slots will be considered per needs

Please contact your customer account manager for additional information.

Fab2 -- Tower Semiconductor 200mm wafer fabrication facility at Migdal Ha'emek, Israel

Fab3 -- Tower Semiconductor 200mm wafer fabrication facility at Newport Beach, CA

Fab5 -- Tower Semiconductor 200mm wafer fabrication facility at Tonami, Japan

Fab7 -- Tower Semiconductor 300mm wafer fabrication facility at Uozu, Japan